

N-Channel Enhancement Mode Power MOSFET

Description

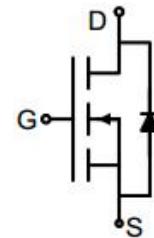
The GT007N04TL uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge. It can be used in a wide variety of applications.

General Features

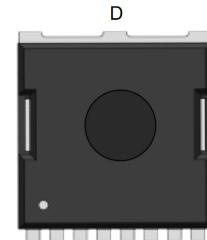
- V_{DS} 40V
- I_D (at $V_{GS} = 10V$) 345A
- $R_{DS(ON)}$ (at $V_{GS} = 10V$) < 1mΩ
- $R_{DS(ON)}$ (at $V_{GS} = 4.5V$) < 1.4mΩ
- 100% Avalanche Tested
- RoHS Compliant

Application

- Power switch
- DC/DC converters



Schematic diagram



G₁ S₂ S₃ S₄ S₅ S₆ S₇ S₈

TOLL-8L

Ordering Information

Device	Package	Marking	Packaging
GT007N04TL	TOLL-8L	GT007N04	2000pcs/Reel

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	40	V
Continuous Drain Current $T_C = 25^\circ\text{C}$	I_D	345	A
$T_C = 100^\circ\text{C}$		218	
Pulsed Drain Current (note1)	I_{DM}	1380	A
Gate-Source Voltage	V_{GS}	± 20	V
Power Dissipation	P_D	159	W
Single pulse avalanche energy (note2)	E_{AS}	441	mJ
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 To 150	°C

Thermal Resistance

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	R_{thJA}	60	°C/W
Thermal Resistance, Junction-to-Case	R_{thJC}	0.78	°C/W

Specifications $T_J = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Parameters						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	40	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 40\text{V}, V_{\text{GS}} = 0\text{V}$	--	--	1	μA
Gate-Source Leakage	I_{GSS}	$V_{\text{GS}} = \pm 20\text{V}$	--	--	± 100	nA
Gate-Source Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	1.0	1.6	2.5	V
Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 75\text{A}$	--	0.84	1.0	$\text{m}\Omega$
		$V_{\text{GS}} = 4.5\text{V}, I_D = 75\text{A}$	--	1.06	1.4	
Forward Transconductance	g_{FS}	$V_{\text{GS}} = 5\text{V}, I_D = 75\text{A}$	--	67	--	S
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 20\text{V}, f = 0.5\text{MHz}$	--	7750	--	pF
Output Capacitance	C_{oss}		--	5100	--	
Reverse Transfer Capacitance	C_{rss}		--	315	--	
Total Gate Charge	Q_g	$V_{\text{DD}} = 20\text{V}, I_D = 75\text{A}, V_{\text{GS}} = 10\text{V}$	--	125	--	nC
Gate-Source Charge	Q_{gs}		--	30	--	
Gate-Drain Charge	Q_{gd}		--	32	--	
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 20\text{V}, I_D = 75\text{A}, R_G = 5\Omega$	--	30	--	ns
Turn-on Rise Time	t_r		--	42	--	
Turn-off Delay Time	$t_{\text{d}(\text{off})}$		--	80	--	
Turn-off Fall Time	t_f		--	31	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_S	$T_C = 25^\circ\text{C}$	--	--	345	A
Body Diode Voltage	V_{SD}	$T_J = 25^\circ\text{C}, I_{\text{SD}} = 75\text{A}, V_{\text{GS}} = 0\text{V}$	--	--	1.2	V
Reverse Recovery Charge	Q_{rr}	$I_F = 75\text{A}, V_{\text{GS}} = 0\text{V}$ $dI/dt = 100\text{A/us}$	--	62	--	nC
Reverse Recovery Time	T_{rr}		--	99	--	ns

Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. EAS condition : $T_J=25^\circ\text{C}$, $V_{\text{DD}}=40\text{V}$, $V_{\text{GS}}=10\text{V}$, $L=0.5\text{mH}$, $R_G=25\Omega$

The table shows the minimum avalanche energy, which is 1225mJ when the device is tested until failure

3. Identical low side and high side switch with identical R_G

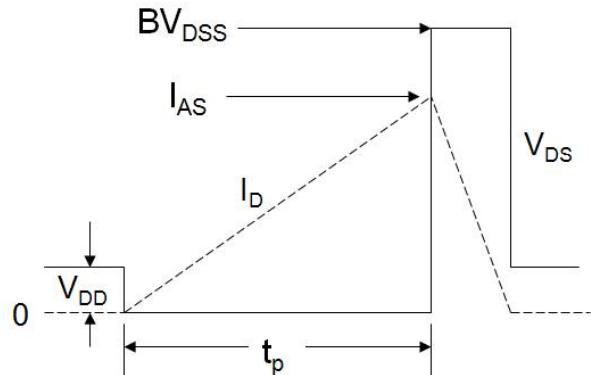
Gate Charge Test Circuit



Switch Time Test Circuit



EAS Test Circuit



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

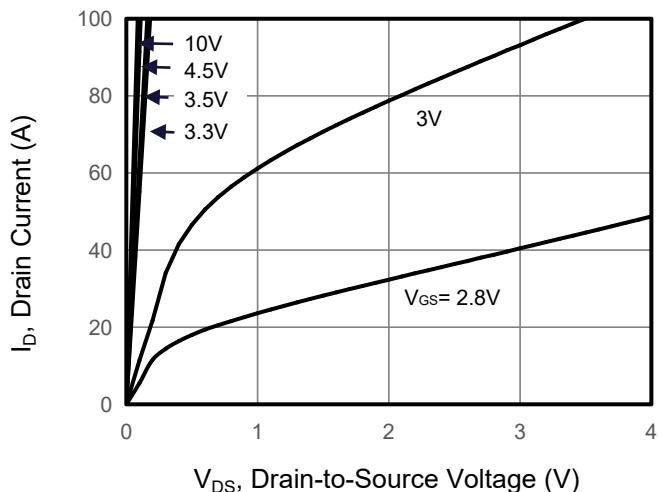


Figure 2. Transfer Characteristics

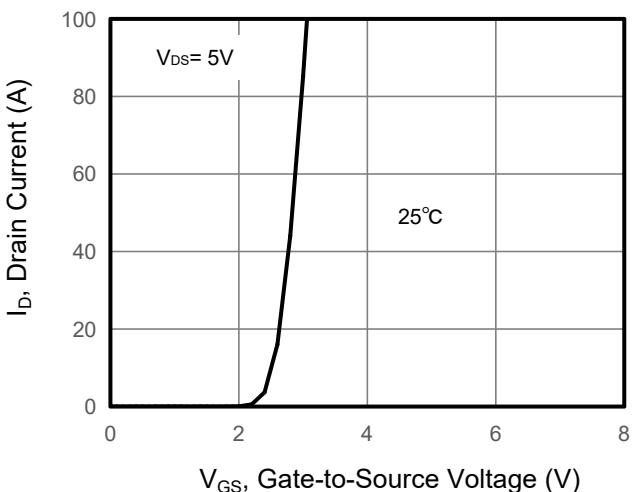


Figure 3. Drain Source On Resistance

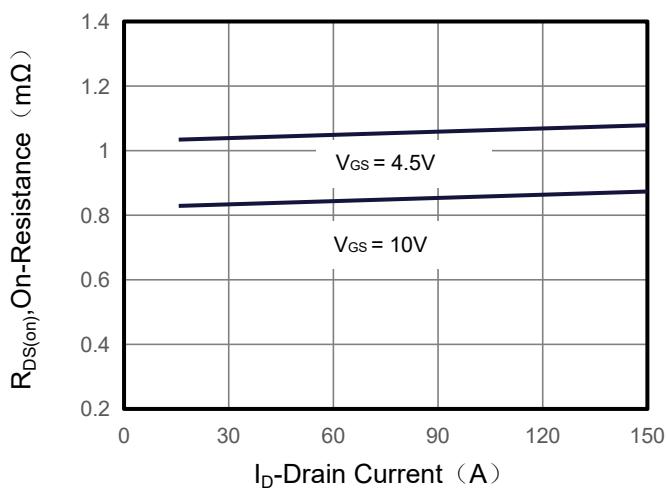


Figure 4. Gate Charge

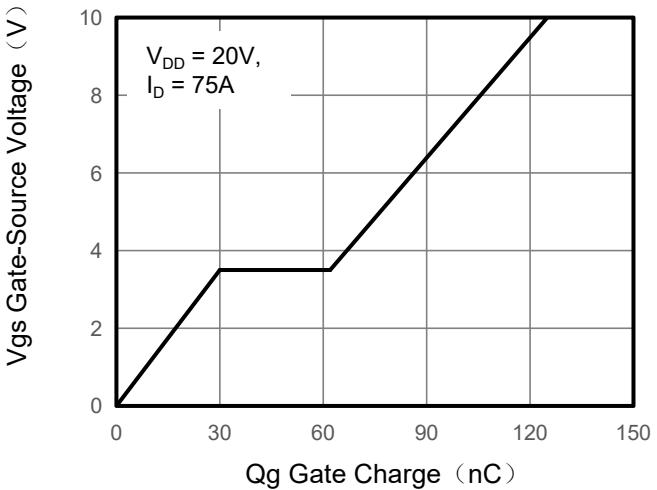


Figure 5. Capacitance

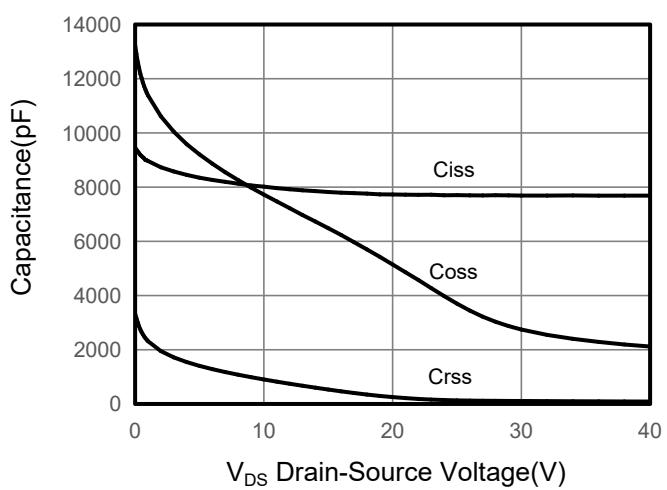
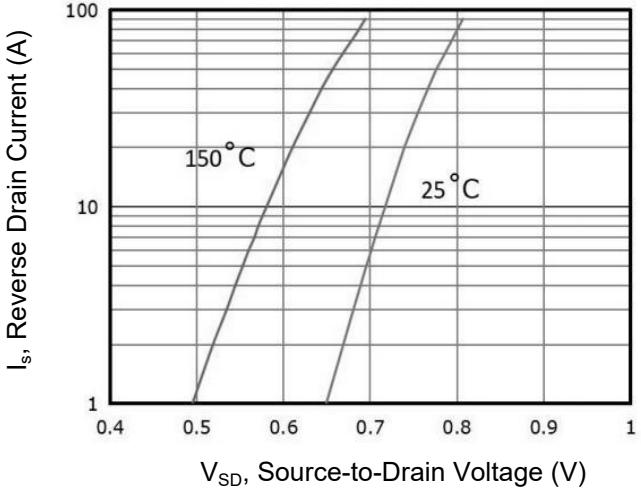


Figure 6. Source-Drain Diode Forward



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. Drain-Source On-Resistance

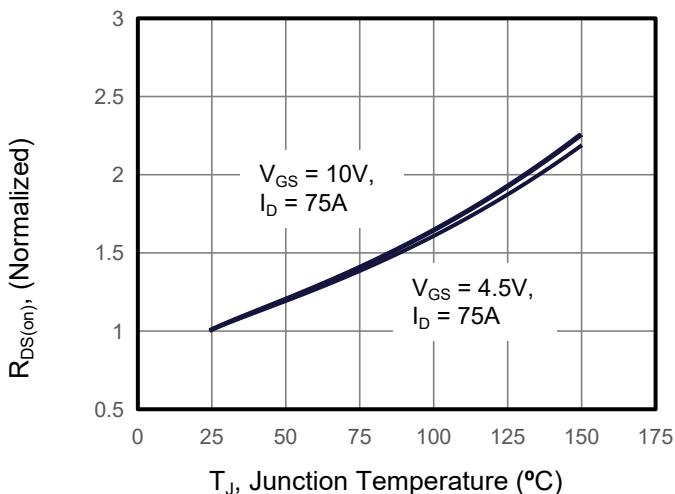


Figure 8. Safe Operation Area

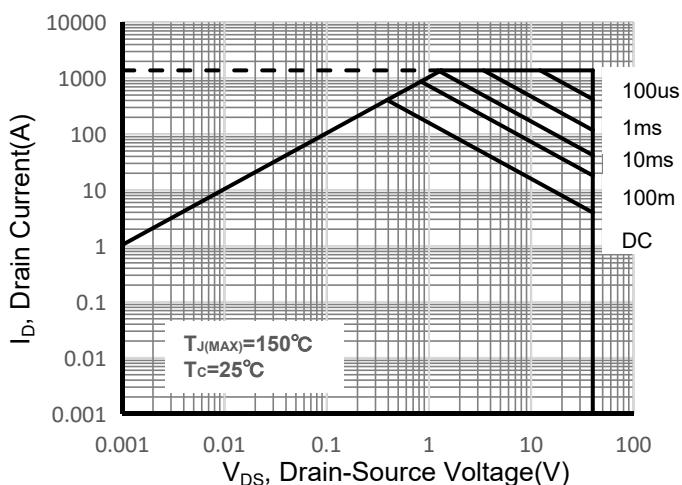


Figure 9. Maximum Continuous Drain Current vs Case Temperature

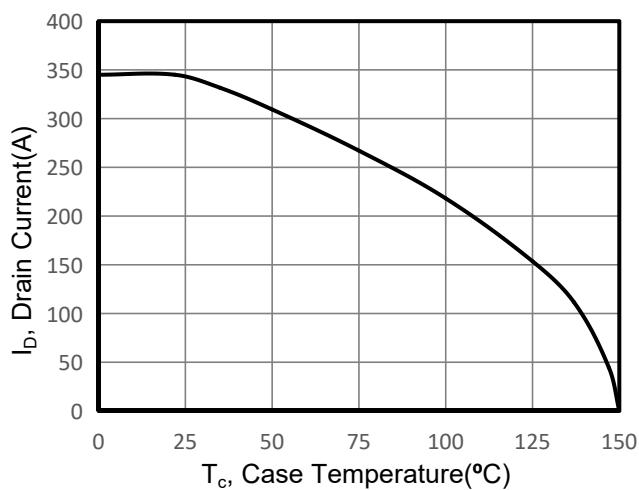
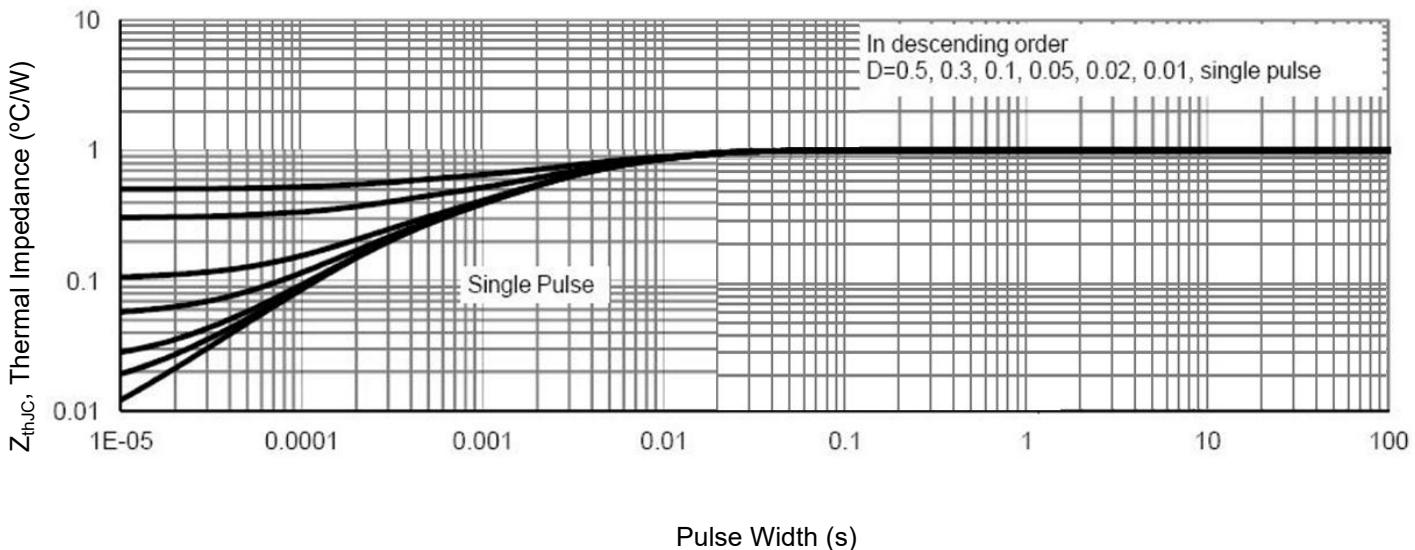
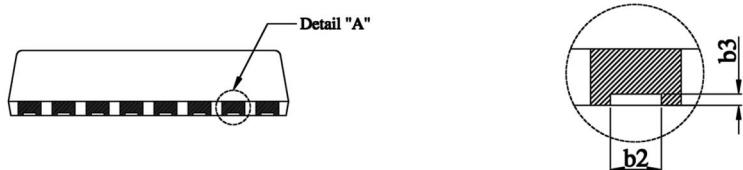
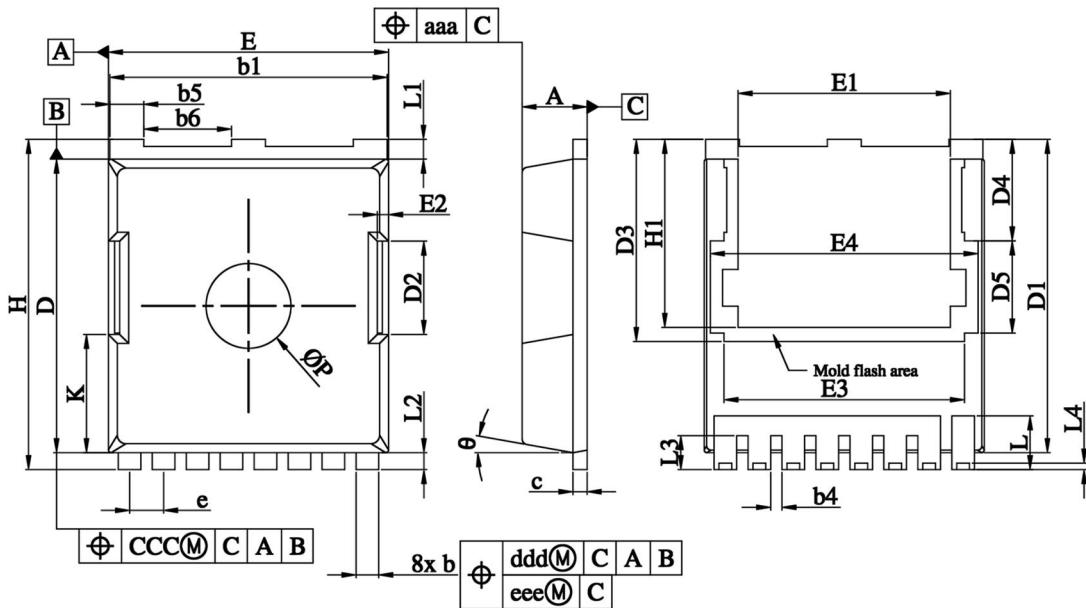


Figure 10. Normalized Maximum



TOLL-8L Package Information



SYMBOL	COMMON			SYMBOL	COMMON			
	MILLIMETER				MILLIMETER			
	MIN.	NOMINAL	MAX.		MIN.	NOMINAL	MAX.	
A	2.20	2.30	2.40	E2	0.30	0.40	0.50	
b	0.70	0.80	0.90	E3		8.50		
b1	9.70	9.80	9.90	E4		9.46		
b2	0.36	0.45	0.55	H	11.50	11.68	11.85	
b3	0.05	0.100	/	H1	6.55	6.65	6.75	
b4	0.30	0.40	0.50	K	4.08	4.18	4.28	
b5	1.10	1.20	1.30	L	1.60	1.90	2.10	
b6	3.00	3.10	3.20	L1	0.50	0.70	0.90	
c	0.40	0.50	0.60	L2	0.50	0.60	0.70	
D	10.28	10.38	10.55	L3	1.00	1.20	1.30	
D1	10.98	11.08	11.18	L4	0.13	0.23	0.33	
D2	3.20	3.30	3.40	P	2.85	3.00	3.15	
D3	7.15			θ	10° REF			
D4	3.59			aaa	0.20			
D5	3.26			ccc	0.20			
e	1.10	1.20	1.30	ddd	0.25			
E	9.80	9.90	10.00	eee	0.20			
E1	7.40	7.50	7.60					